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10/24/02  
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Shyh-Ming Chang

Group Art Unit: 2813

Serial No.: 09/634,556

Examiner: Thanhha S. Pham

Filed: Aug. 7, 2000

In Response to Office Action  
Dated: July 15, 2002

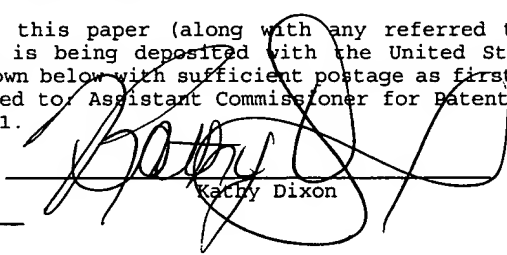
For: Method for Forming Electrically Conductive  
Bumps and Devices Formed

Attorney Docket No.: 64,600-065

Certificate of Mailing

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to Assistant Commissioner for Patents, Washington, D.C. 20231.

Date: Oct. 15, 2002

  
Kathy Dixon

RESPONSE TO OFFICE ACTION

Assistant Commissioner  
for Patents  
Washington, D.C. 20231

Dear Sir:

In response to an Office Action mailed July 15, 2002,  
please consider the following remarks.

RECEIVED  
OCT 23 2002  
TECHNOLOGY CENTER 2800